

Specification LW540AS

SSC		CUSTOMER
Drawn	Approval	Approval

Rev. 04

March 2009

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CONTENTS

- 1. Full code of Lamp LED series
- 2. Feature & Application
- 3. Absolute Maximum Ratings
- 4. Electro Characteristics
- 5. Outline Dimension
- 6. Optical characteristics
- 7. Color & Binning
- 8. Rank of LW540AS
- 9. Packing
- 10. Soldering
- 11. Precaution for use
- 12. Reliability Test Item and Condition

Rev. 04



1. Full Code of Lamp LED Series

Full code form : $X_1 X_2 X_3 X_4 X_5 X_6 X_7 X_8 X_9 - X_{10} X_{11}$

1. Part Number

- X₁: Model
- X₂: Number of Die *1
- X₃: Color
- X₄: Lens Shape
- X₅: Directivity
- X₆: Revision Symbol
- X₇: High Reliability *2
- X₈: Surface coloring & Diffusion *3
- X_o: Stopper *4
- *1, 2, 3, 4 are added to the Product Type only in necessary cases.

2. Internal Number

- X₁₀
- X₁₁

3. Sticker Diagram on Box & Aluminum Vinyl Bag



For more information about binning and labeling, refer to the Application Note -1

Rev. 04

March 2009

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LW540AS

LW540AS

Description

Lamp LEDs are effective in hot thermal and humid condition.

This high brightness and weather-resistant packaging design makes these Lamp LEDs ideal for Outdoor applications such as traffic signals, variable message signs and backlighting for transparent sign panels.





Features

- High luminous white emission
- Stopper Type leads
- 5mm package
- Viewing angle: 40°
- Color Coordinates :x=0.31 y=0.31

Applications

- Electronic signs and signals
- Specialty lighting
- Small area illumination
- Torches and head lamps
- Backlighting
- Outdoor displays

Rev. 04

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3. Absolute maximum ratings

Parameter	Symbol	Value	Unit
DC Forward Current	I _F	30	mA
Forward Peak Pulse Current	I _{FP} *1	100	mA
Reverse Voltage	V_R	5	V
Power Dissipation	P_D	114	mW
Operating Temperature	T _{opr}	-35 ~ 85	°C
Storage Temperature	T _{stg}	-40 ~ 100	°C
Solder Temperature	T_s	260°C for 10seconds *2	°C

^{*1} $t \le 0.1$ ms, D = 1/10

4. Electric & Optical characteristics

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Luminous Intensity *3	I_V	lf=20mA	3500	6000		mcd
Luminous Flux	Φ_{V}	lf=20mA	-	4	-	lm
Chromaticity Coordinate*4	<i>x, y</i>	lf=20mA	X=	=0.31, y=0.	31	-
Forward Voltage *5	V_F	lf=20mA	-	3.3	3.8	V
View Angle	2θ _½	If=20mA		40		Deg.
Optical Efficiency	$\mathcal{D}_{ ext{elc}}$	lf=20mA	-	60	-	lm/W
Reverse Current	I _R	V _R = 5V	-	-	5	μΑ

^{*3.} SSC maintains a tolerance of $\pm 10\%$ on intensity and power measurements.

[Note] All measurements were made under the standardized environment of SSC.

Rev. 04

March 2009

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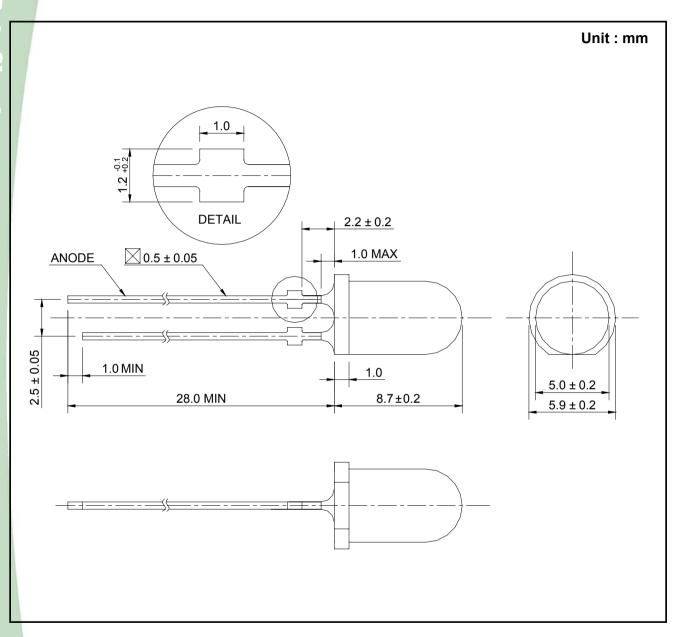
^{*2} No lower than 3mm from the base of the epoxy bulb.

^{*4.} Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram. It is measured with an integrated sphere. Color Coordinates Measurement allowance is \pm 0.01

^{*5.} A tolerance of ± 0.05 V on forward voltage measurements



5.Outline Dimension



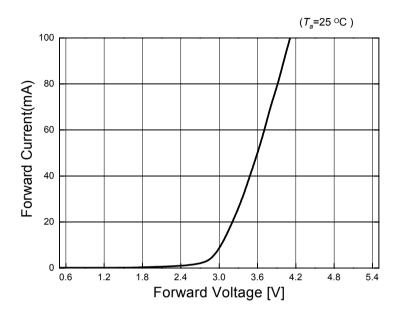
Notes: Protruded epoxy is 1.0mm maximum.

Rev. 04

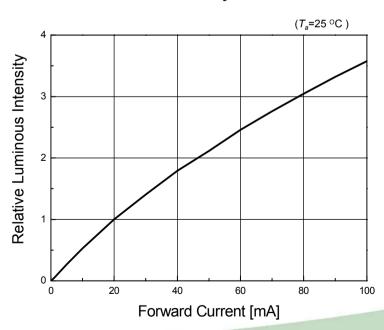
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Forward Current vs. Forward Voltage



Relative Luminous Intensity vs Forward Current



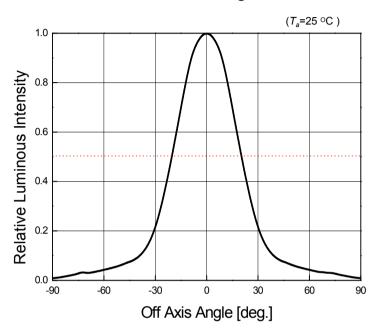
Rev. 04

March 2009

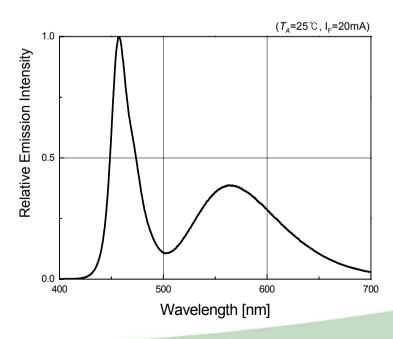
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Radiation Diagram



Spectrum



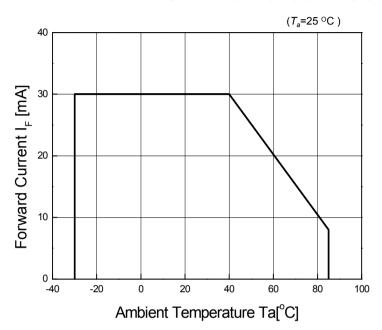
Rev. 04

March 2009

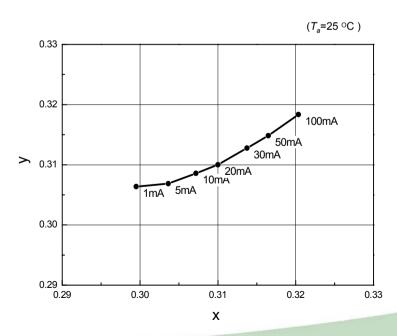
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Ambient Temperature vs. Maximum Forward Current



Forward Current vs. Chromaticity Coordinate



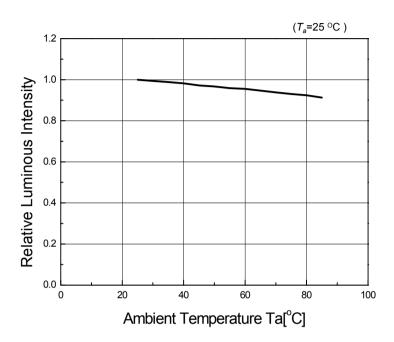
Rev. 04

March 2009

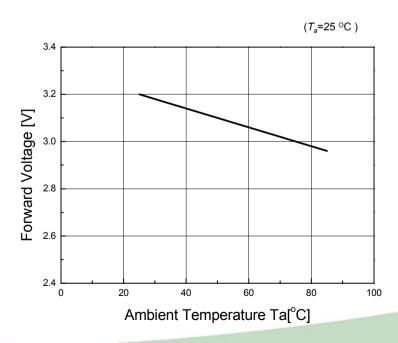
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Ambient Temperature vs. Relative Intensity



Ambient Temperature vs. Forward Voltage



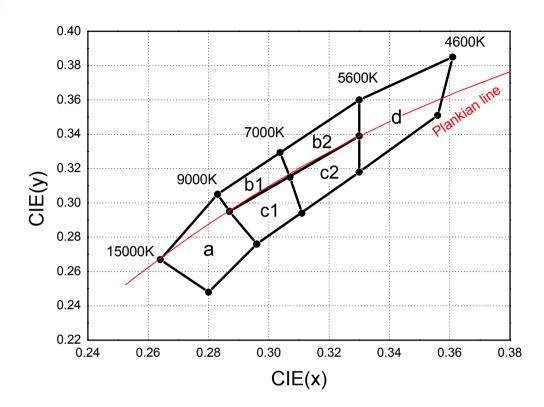
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March 2009

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7. Color & Binning



						ı					_
			Rar	nk a					Ran	k b1	
	х	0.264	0.280	0.296	0.283	$\ \ $	X	0.287	0.283	0.304	
	у	0.267	0.248	0.276	0.305		у	0.295	0.305	0.330	
		Rank b2					Ran	k c1	_		
4	х	0.307	0.304	0.330	0.330		Х	0.296	0.287	0.307	
	у	0.315	0.330	0.360	0.339		у	0.276	0.295	0.315	
Γ		Rank c2					Rar	nk d	_		
	×	0.311	0.307	0.330	0.330		Х	0.330	0.330	0.356	
	У	0.294	0.315	0.339	0.318		у	0.360	0.318	0.351	

Note : Color Coordinates Measurement allowance is \pm 0.01

Rev. 04

March 2009

0.307

0.315

0.311

0.294

0.361

0.385

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8. Rank of LW540AS

	Bin Code	
Luminous Intensity	CIE	Forward Voltage
Q	c1	4







Luminous Intensity (mcd) @ $I_F = 20$ mA				
Bin Code	Min.	Max.		
Р	3500	5000		
Q	5000	7000		
R	7000	10000		

Color Rank
@ $I_F = 20 \text{mA}$
а
b1
b2
c1
c2
d

Forward Voltage (V) @ I _F = 20mA				
Bin Code	Min.	Max.		
3	2.8	3.0		
4	3.0	3.2		
5	3.2	3.4		
6	3.4	3.6		
7	3.6	3.8		
8	3.8	4.0		

■ Available ranks

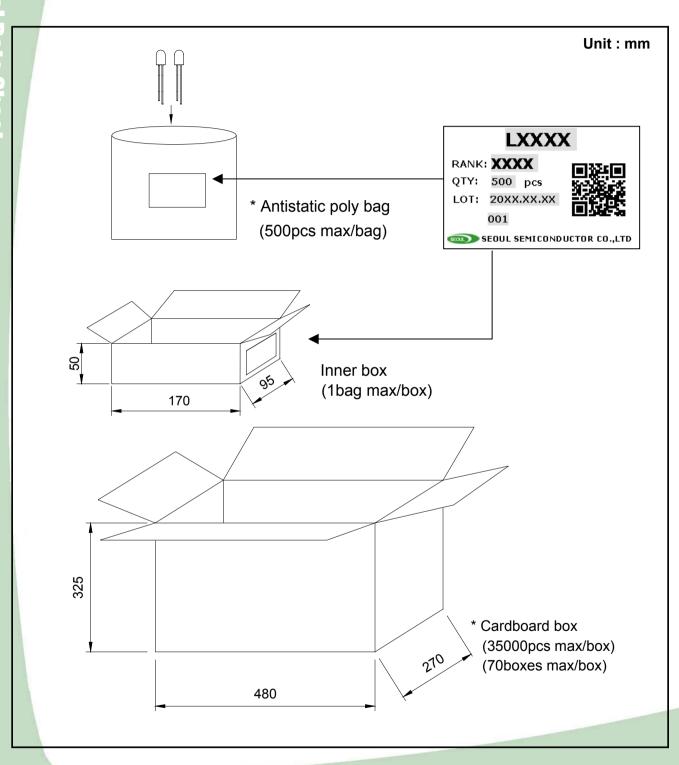
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9. Packing

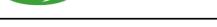


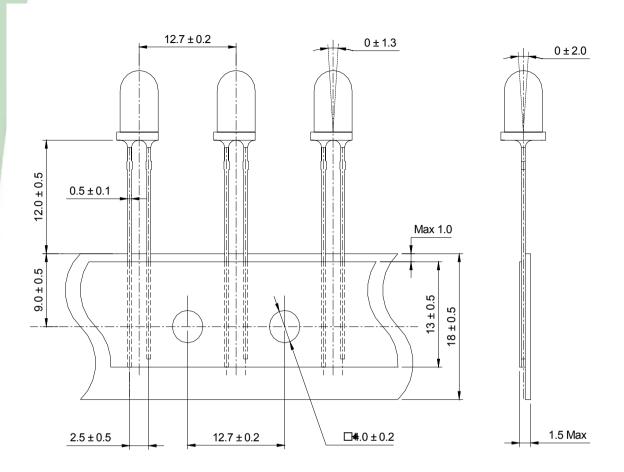
Rev. 04

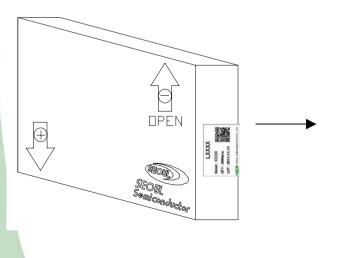
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Unit: mm







LXXXX

RANK: XXXX

QTY: 2000pcs

LOT: 20XX.XX.XX





SEOUL SEMICONDUCTOR CO., LTD

1 Box contain quantity.

* 3 Series : 3000pcs/box

* 5 h Series : 2000pcs/box

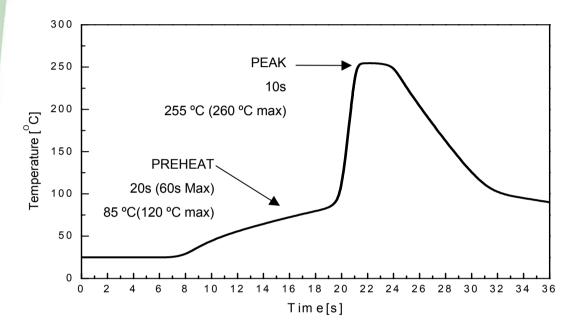
Rev. 04

March 2009



10. Soldering

- 1) Wave Soldering Conditions / Profile
- Preliminary heating to be at 85°C(120 °C max) for 20 seconds(60 seconds max).
- Soldering heat to be at 255 °C (260°C max) for 10 seconds
- Soak time above 200 °C is 5 seconds



2) Hand Soldering conditions

• Not more than 3 seconds at max. 350°C, under Soldering iron.

3) Caution

- The LEDs must not be repositioned after soldering.
- Do not apply any stress to the lead particularly when heat.

Note: In case the soldered products are reused in soldering process, we don't guarantee the products.

KeV. U²



11. Precaution for use

1) Storage

- · Before opening the package
 - a. Avoid the absorption of moisture, we recommended to store the LEDs in a dry box(or desiccator) with a desiccant . Otherwise, store them in the following environment: Temperature: $5\%\sim30\%$ Humidity: 50% max.
 - b. The products should be used in 3 months. It is recommended that the LEDs be used as soon as possible.
- After opening the package
 - a. Soldering should be done right after opening the package(within 24Hrs).
 - b. Keeping of a fraction
 - Sealing
 - Temperature : 5 ~ 40 $^{\circ}$ C, Humidity : less than 30%
- Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temp. after soldering.
- · Avoid quick cooling
- Lead frames are silver plated SPCC. The silver plate surface may be affected by environments which contains corrosive substances. Please avoid conditions which may cause the LEDs to corrode, tarnish or discolor.

2) Lead Forming

- When the lead forming is required before soldering, care must be taken to avoid any bending and mechanical stress. The stress to the base may damage the LEDs.
- When mounting the LEDs onto a PCB, the holes on the circuit board should be exactly aligned with the leads of the LEDs.
- It is recommended that tooling made to precisely form and cut the leads to length rather than rely on hand operating.

Rev. 04



3) Static Electricity

- Static Electricity and surge voltage damage the LEDs. So it is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs.
- All devices, equipment and machinery must be grounded properly. It is recommended that
 precautions should be taken against surge voltage to the equipment that mounts the LEDs.

4) Heat Generation

- Thermal is one of the important parameters to design the end product. Please consider the heat generation of the LEDs.
- The operating current should be decided after considering the ambient maximum temperature of LEDs.

5) Others

- The color of the LEDs is changed slightly an operating current and thermal.
- Anti radioactive ray design is not considered for the products listed here.
- Gallium arsenide is used in some of the products listed in this publication. These products
 are dangerous if they are burned or smashed in the process of disposal. It is also dangerous
 to drink the liquid or inhale the gas generated by such products when chemically disposed.
- This device should not be used in any type of fluid such as water, oil, organic solvent and etc.

 When washing is required, IPA(Isopropyl Alcohol) should be used.
- When the LEDs are illuminating, operating current should be decided after considering the junction temperature.
 - Cf.) Please refer Ambient temperature vs. Forward Current graph on page 5
- The appearance and specifications of the product may be modified for improvement without notice.

Rev. 04



12. Reliability Test Item and Condition

Item	Condition	Note	Failures
Life Test	$T_a = RT, I_F = 30mA$	1000hrs	0/22
High Temperature Operating	$T_a = 85^{\circ}\text{C}, \ I_F = 8\text{mA}$	1000hrs	0/22
Low Temperature Operating	$T_a = -30^{\circ}\text{C}, \ I_F = 20\text{mA}$	1000hrs	0/22
Thermal Shock	T_a = -40°C (30min) ~ 100° (30min) (Transfer time : 10sec, 1Cycle = 1hr)	100 cycles	0/40
Resistance to soldering Heat	$T_s = 255 \pm 5^{\circ}\text{C}, \ t = 10\text{sec}$	1 time	0/22
ESD (Human Body Model)	1kV, 1.5kΩ ; 100pF	1 time	0/22
High Temperature Storage	T _a = 100°C	1000hrs	0/22
Low Temperature Storage	T _a = -40°C	1000hrs	0/22
Temperature Humidity Storage	T _a = 85°C, RH = 85%	1000hrs	0/22
Temperature Humidity Operating	$T_a = 85$ °C, $RH = 85$ %, $I_F = 8$ mA	100hrs	0/22

< Judging Criteria For Reliability Tests >

V_{F}	USL ^[1] X 1.2
I _R	USL X 2.0
Φ_{V}	LSL [2] X 0.7

Notes:

[1] USL: Upper Standard Level [2] LSL: Lower Standard Level.

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March 2009

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